

C0805C241JBGACTU

Aliases (C0805C241JBGAC7800) SMD Comm COG HV, Ceramic, 240 pF, 5%, 630 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

0% Loss/Decade Hour

100 GOhms

	Specifications	
805	Capacitance	240 pF
mm +/-0.2mm	Measurement Condition	1 MHz 1.0Vrms
25mm +/-0.2mm	Tolerance	5%
25mm +/-0.15mm	Voltage DC	630 VDC
).7mm MIN	Dielectric Withstanding Voltage	945 VDC
).5mm +/-0.25mm	Temperature Range	-55/+125°C
&R, 180mm, Plastic Tape 500	Temp. Coefficient	COG
	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
	Dissipation Factor	0.1% 1 MHz 1.0Vrms

Aging Rate

Insulation Resistance

Click here for the 3D model.

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
т	1.25mm +/-0.15mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications Packaging Т8 25 Packaging Quantity